MOSFET - POWERTRENCH[®] N-Channel

80 V, 300 A, 1.4 mΩ

FDBL86361-F085

Features

- Typical $R_{DS(on)} = 1.1 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 172 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems

MOSFET MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

	-		
Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	80	V
V _{GS}	Gate-to-Source Voltage	±20	V
۱ _D	Drain Current – Continuous (V _{GS} = 10), T _C = 25°C (Note 1)	300	A
	Pulsed Drain Current, $T_{C} = 25^{\circ}C$	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 2)	820	mJ
PD	Power Dissipation	429	W
	Derate Above 25°C	2.86	W/∘C
T _J , T _{STG}	Operating and Storage Temperature	–55 to +175	°C
R_{\thetaJC}	Thermal Resistance, Junction to Case	0.35	°C/W
$R_{ hetaJA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)	43	°C/W

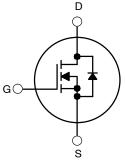
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by bondwire configuration.
- 2. Starting $T_J = 25^{\circ}$ C, $\dot{L} = 0.4$ mH, $I_{AS} = 64$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.



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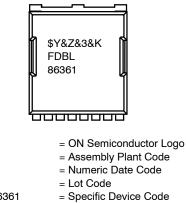


N-Channel



H-PSOF8L CASE 100CU

MARKING DIAGRAM



FDBL86361

\$Y

&Z

&З

&K

ORDERING INFORMATION

Device	Top Mark	Package	$\mathbf{Shipping}^{\dagger}$
FDBL86361 -F085	FDBL86361	H-PSOF8L	2000 Units/ Tape&Reel

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit	
OFF CHARAC	OFF CHARACTERISTICS							
BV _{DSS}	Drain-to-Source Breakdown Voltage	I_D = 250 μ A, V_{GS} = 0 V		80	_	-	V	
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 80 V, V _{GS} = 0 V	$T_J = 25^{\circ}C$	-	-	1	μA	
			T _J = 175°C (Note 4)	-	_	1	mA	
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20 V		-	_	±100	nA	

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$		2.0	3.0	4.0	V
R _{DS(on)}	Drain to Source on Resistance	I _D = 80 A,	$T_J = 25^{\circ}C$	-	1.1	1.4	mΩ
		V _{GS} = 10 V	T _J = 175°C (Note 4)	-	2.4	3.1	mΩ

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 40 V, V_{GS} = 0 V, f = 1 MHz	-	12800	-	pF
C _{oss}	Output Capacitance		-	1925	-	pF
C _{rss}	Reverse Transfer Capacitance		-	139	-	pF
Rg	Gate Resistance	f = 1 MHz	-	2.7	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	$V_{GS} = 0$ to 10 V	-	172	188	nC
Q _{g(th)}	Threshold Gate Charge	V _{DD} = 64 V V _{GS} = 0 to 2 V	-	23	27	nC
Q _{gs}	Gate-to-Source Gate Charge	I _D = 80 A	-	51	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge		-	34	-	nC

SWITCHING CHARACTERISTICS

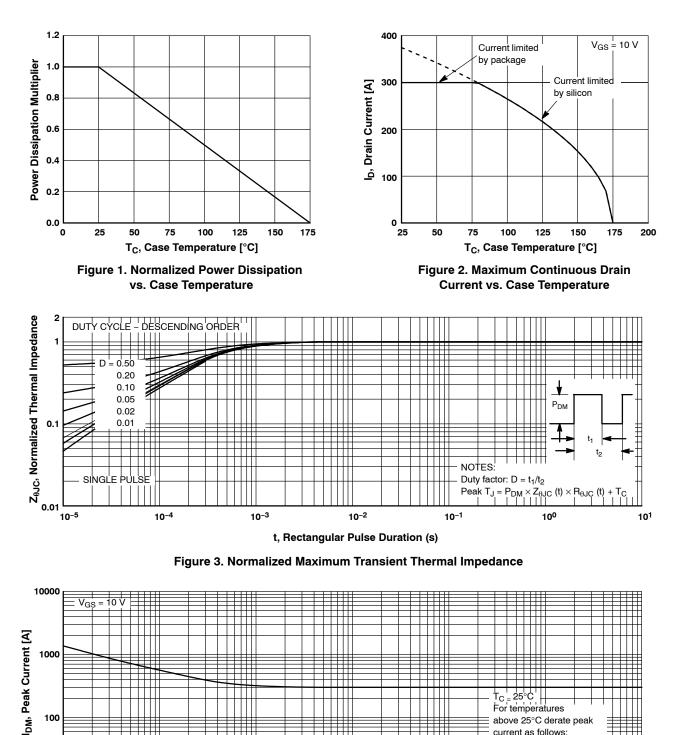
t _{on}	Turn-On Time	V_{DD} = 40 V, I _D = 80 A, V _{GS} = 10 V, R _{GEN} = 6 Ω	-	_	128	ns
t _{d(on)}	Turn-On Delay		-	42	-	ns
t _r	Rise Time		-	73	-	ns
t _{d(off)}	Turn-Off Delay		-	87	-	ns
t _f	Fall Time		-	48	-	ns
t _{off}	Turn-Off Time		-	-	193	ns

DRAIN-SOURCE DIODE CHARACTERISTIC

V _{SD}	Source-to-Drain Diode Voltage	I_{SD} = 80 A, V_{GS} = 0 V	-	-	1.25	V
		I_{SD} = 40 A, V_{GS} = 0 V	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	$I_{F} = 80 \text{ A}, \text{ dI}_{SD}/\text{dt} = 100 \text{ A}/\mu\text{s},$	-	117	136	ns
Q _{rr}	Reverse-Recovery Charge	V _{DD} = 64 V	-	205	269	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS





10⁻²

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10⁻³

100

10 10-5

10-4

ТП

10⁻¹

 $T_{C} = 25^{\circ}C$ For temperatures

above 25°C derate peak

175 – T_C

150

10¹

10⁰

current as follows:

1,2

TYPICAL CHARACTERISTICS (continued)

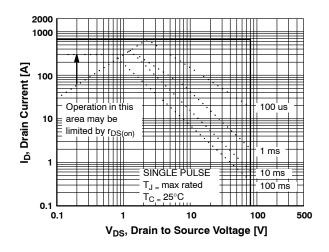


Figure 5. Forward Bias Safe Operating Area

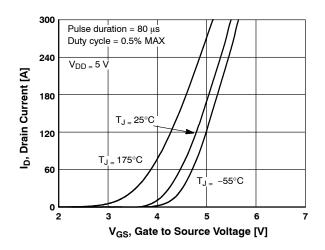
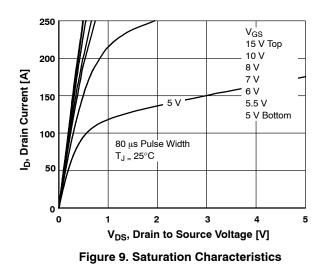


Figure 7. Transfer Characteristics



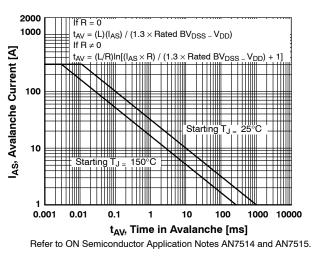
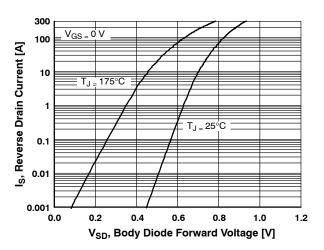
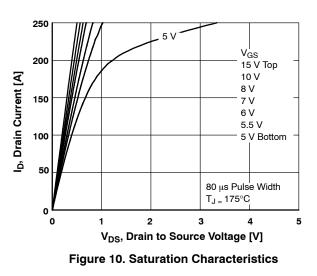


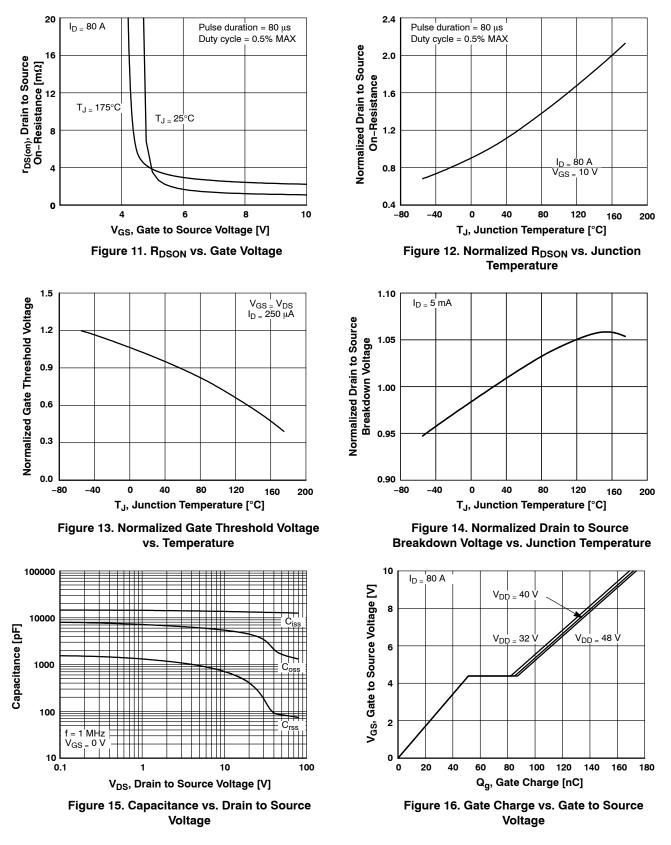
Figure 6. Unclamped Inductive Switching Capability





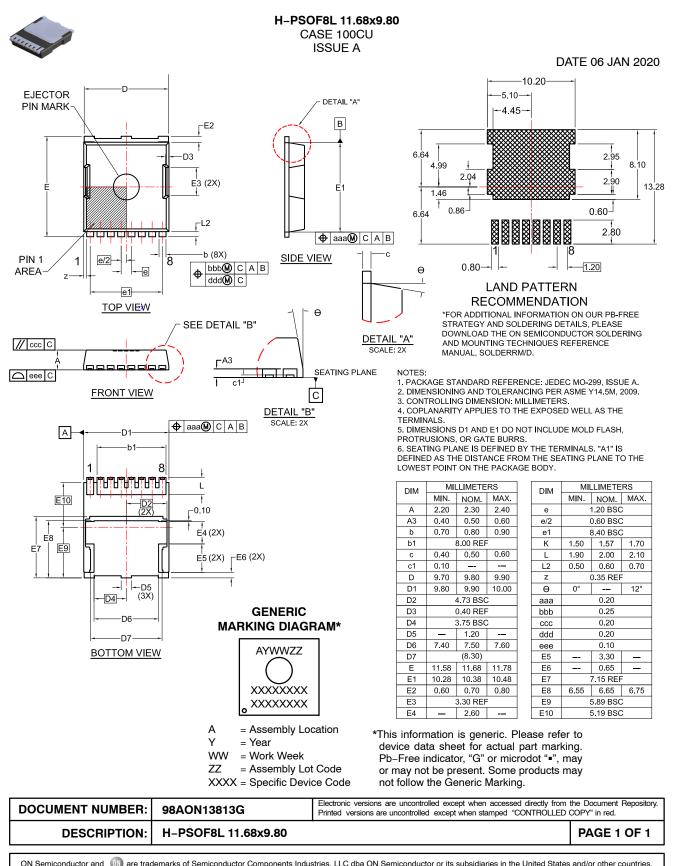


TYPICAL CHARACTERISTICS (continued)



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